

## OptiMOS®2 Small-Signal-Transistor

### Product Summary

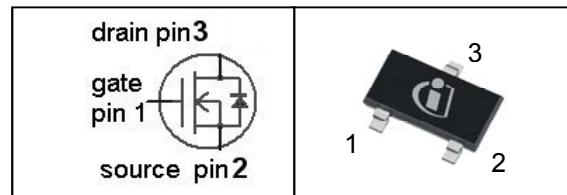
#### Features

- N-channel
- Enhancement mode
- Super Logic level (2.5V rated)
- Avalanche rated
- Footprint compatible to SOT23
- dv/dt rated
- Pb-free lead plating; RoHS compliant
- Qualified according to AEC Q101



$V_{DS}$	20	V
$R_{DS(on),max}$	$V_{GS}=4.5\text{ V}$	21
	$V_{GS}=2.5\text{ V}$	33
$I_D$	3.8	A

PG-SC-59



Type	Package	Tape and Reel Information	Marking	Lead Free	Packing
BSR202N	PG-SC-59	L6327 = 3000 pcs. / reel	LAs	Yes	Non dry

**Maximum ratings**, at  $T_j=25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	$I_D$	$T_A=25\text{ }^\circ\text{C}$	3.8	A
		$T_A=70\text{ }^\circ\text{C}$	3.1	
Pulsed drain current	$I_{D,pulse}$	$T_A=25\text{ }^\circ\text{C}$	15.2	
Avalanche energy, single pulse	$E_{AS}$	$I_D=3.8\text{ A}, R_{GS}=25\Omega$	30	mJ
Reverse diode dv/dt	dv/dt	$I_D=3.8\text{ A}, V_{DS}=16\text{ V}, di/dt=200\text{ A}/\mu\text{s}, T_{j,max}=150\text{ }^\circ\text{C}$	6	kV/ $\mu\text{s}$
Gate source voltage	$V_{GS}$		$\pm 12$	V
Power dissipation	$P_{tot}$	$T_A=25\text{ }^\circ\text{C}$	0.5	W
Operating and storage temperature	$T_j, T_{stg}$		-55 ... 150	$^\circ\text{C}$
ESD Class		JESD22-A114-HBM	0 (0V to 250V)	
Soldering Temperature			260 $^\circ\text{C}$	
IEC climatic category; DIN IEC 68-1			55/150/56	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

**Thermal characteristics**

Thermal resistance, junction - minimal footprint	$R_{\text{thJA}}$		-	-	250	K/W
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**Electrical characteristics**, at  $T_j=25$  °C, unless otherwise specified

**Static characteristics**

Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0$ V, $I_D=250$ µA	20	-	-	V
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=30$ µA	0.7	0.95	1.2	
Drain-source leakage current	$I_{\text{DSS}}$	$V_{\text{DS}}=20$ V, $V_{\text{GS}}=0$ V, $T_j=25$ °C	-	-	1	µA
		$V_{\text{DS}}=20$ V, $V_{\text{GS}}=0$ V, $T_j=150$ °C	-	-	100	
Gate-source leakage current	$I_{\text{GSS}}$	$V_{\text{GS}}=12$ V, $V_{\text{DS}}=0$ V	-	-	100	nA
Drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=2.5$ V, $I_D=3$ A	-	25	33	mΩ
		$V_{\text{GS}}=4.5$ V, $I_D=3.8$ A	-	17	21	
Transconductance	$g_{\text{fs}}$	$ V_{\text{DS}} >2 I_D R_{\text{DS}(\text{on})\text{max}},$ $I_D=3.8$ A		17	-	s

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

**Dynamic characteristics**

Input capacitance	$C_{iss}$	$V_{GS}=0 \text{ V}, V_{DS}=10 \text{ V}, f=1 \text{ MHz}$	-	863	1147	pF
Output capacitance	$C_{oss}$		-	278	370	
Reverse transfer capacitance	$C_{rss}$		-	40	60	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=10 \text{ V}, V_{GS}=4.5 \text{ V}, I_D=3.8 \text{ A}, R_G=6 \Omega$	-	8.8	-	ns
Rise time	$t_r$		-	16.7	-	
Turn-off delay time	$t_{d(off)}$		-	19	-	
Fall time	$t_f$		-	3.7	-	

**Gate Charge Characteristics**

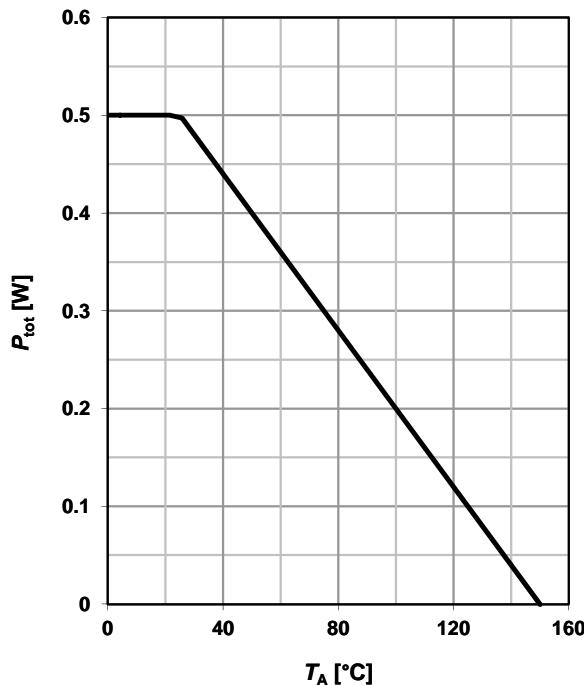
Gate to source charge	$Q_{gs}$	$V_{DD}=10 \text{ V}, I_D=3.8 \text{ A}, V_{GS}=0 \text{ to } 4.5 \text{ V}$	-	1.66	2.21	nC
Gate to drain charge	$Q_{gd}$		-	1.1	1.6	
Gate charge total	$Q_g$		-	5.8	8.8	
Gate plateau voltage	$V_{plateau}$		-	1.9	-	V

**Reverse Diode**

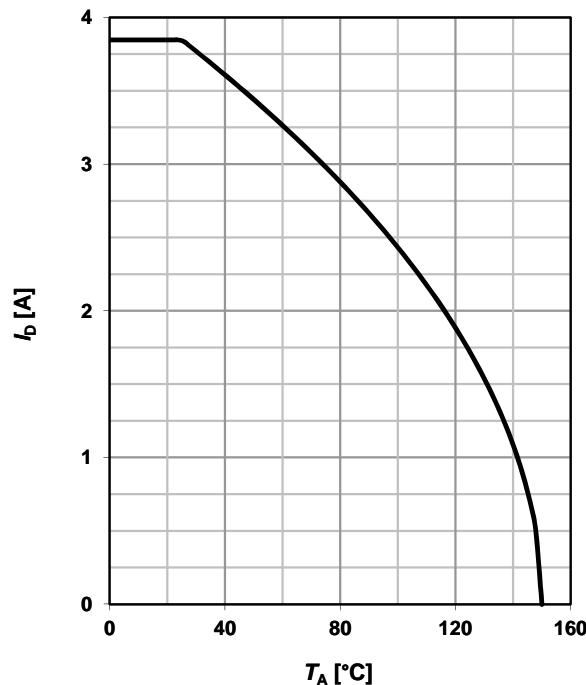
Diode continuous forward current	$I_s$	$T_A=25 \text{ }^\circ\text{C}$	-	-	0.8	A
Diode pulse current	$I_{s,pulse}$		-	-	15.2	
Diode forward voltage	$V_{SD}$	$V_{GS}=0 \text{ V}, I_F=3.8 \text{ A}, T_j=25 \text{ }^\circ\text{C}$	-	0.8	1.1	V
Reverse recovery time	$t_{rr}$	$V_R=10 \text{ V}, I_F=3.8 \text{ A}, di_F/dt=100 \text{ A}/\mu\text{s}$	-	14.3	-	ns
Reverse recovery charge	$Q_{rr}$		-	7.6	-	nC

**1 Power dissipation**

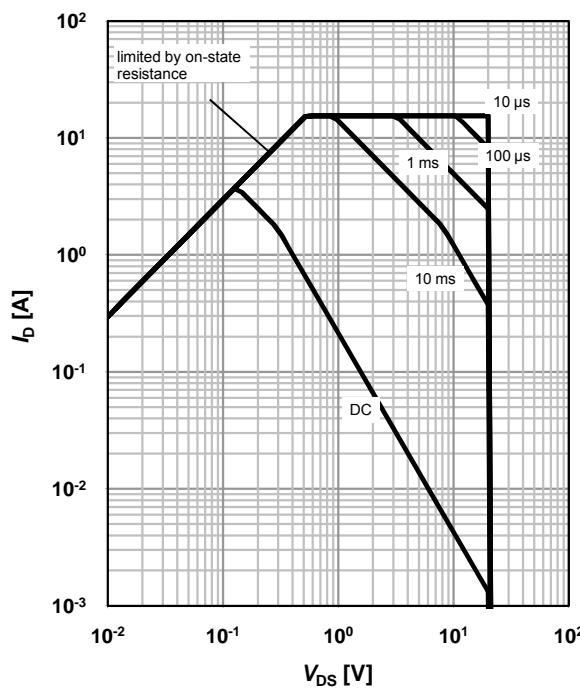
$$P_{\text{tot}} = f(T_A)$$


**2 Drain current**

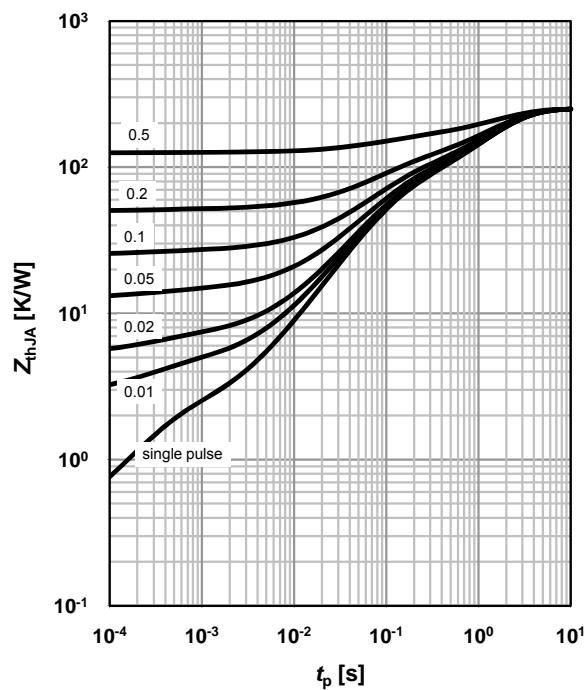
$$I_D = f(T_A); V_{GS} \geq 4.5 \text{ V}$$

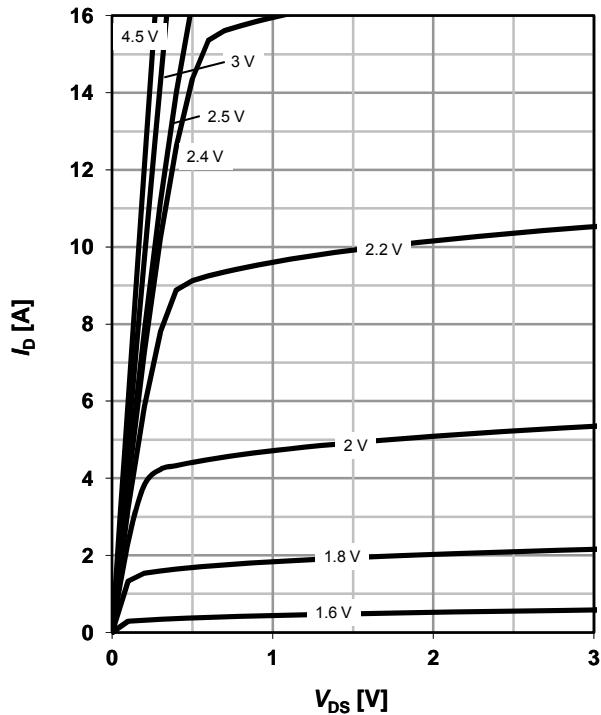
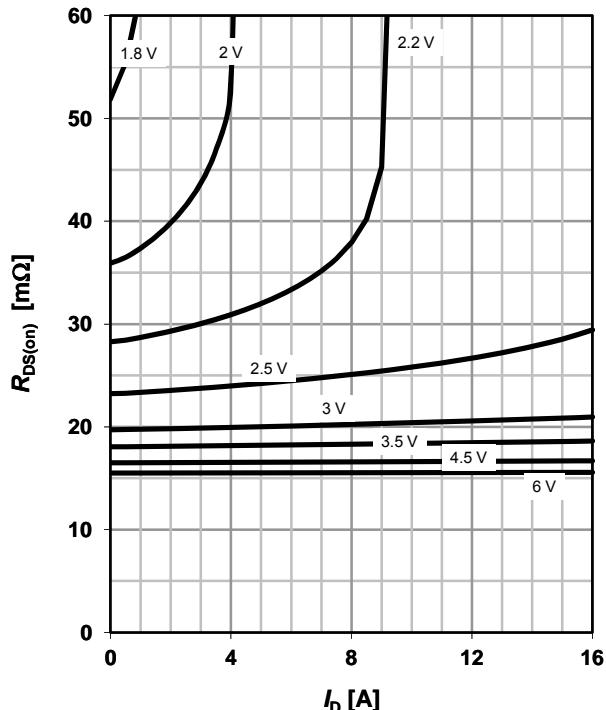
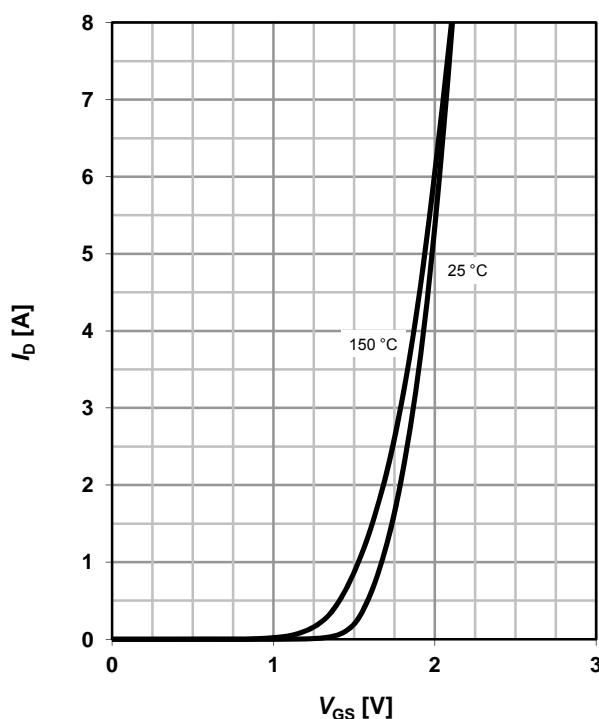
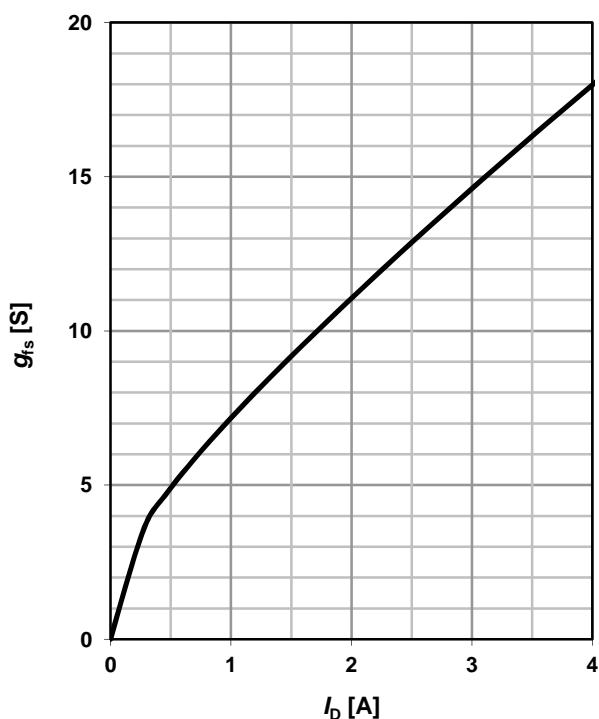

**3 Safe operating area**

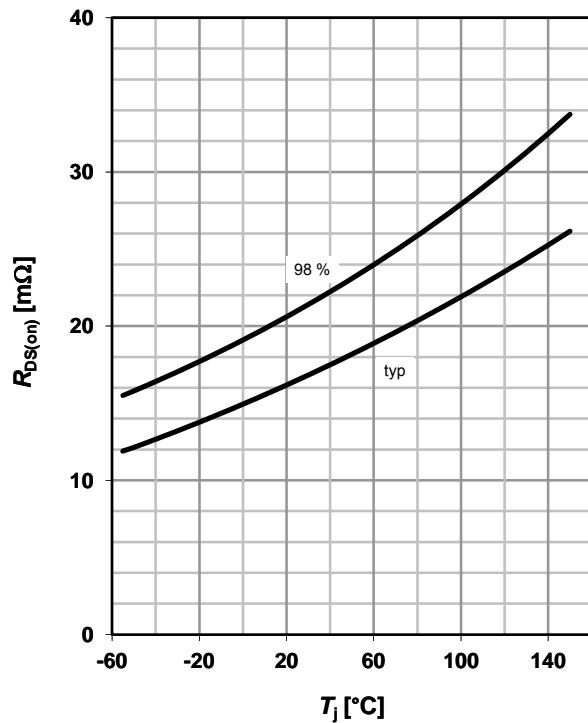
$$I_D = f(V_{DS}); T_A = 25 \text{ °C}; D = 0$$

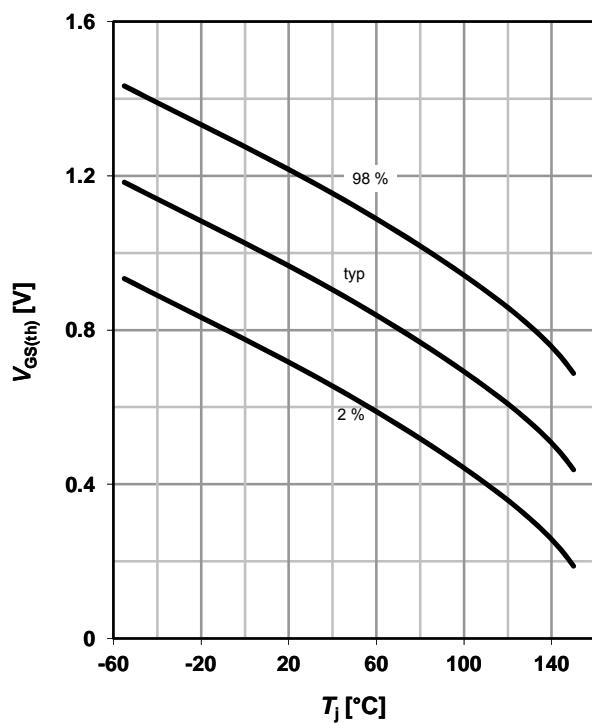
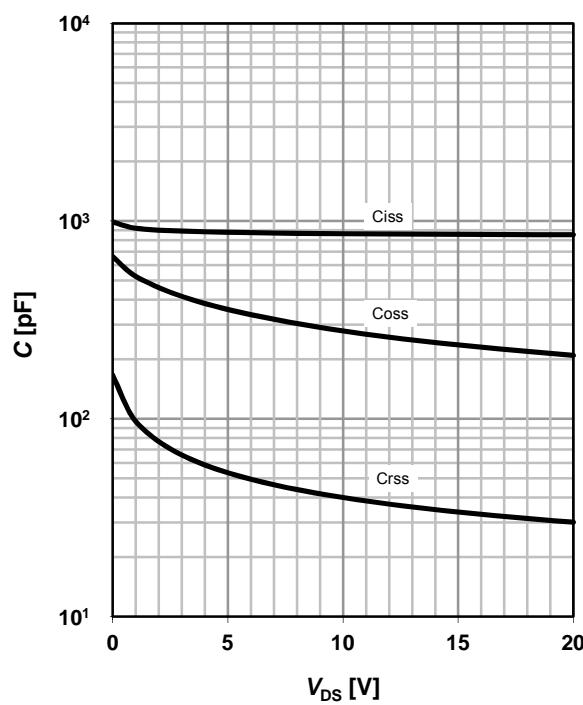
 parameter:  $t_p$ 

**4 Max. transient thermal impedance**

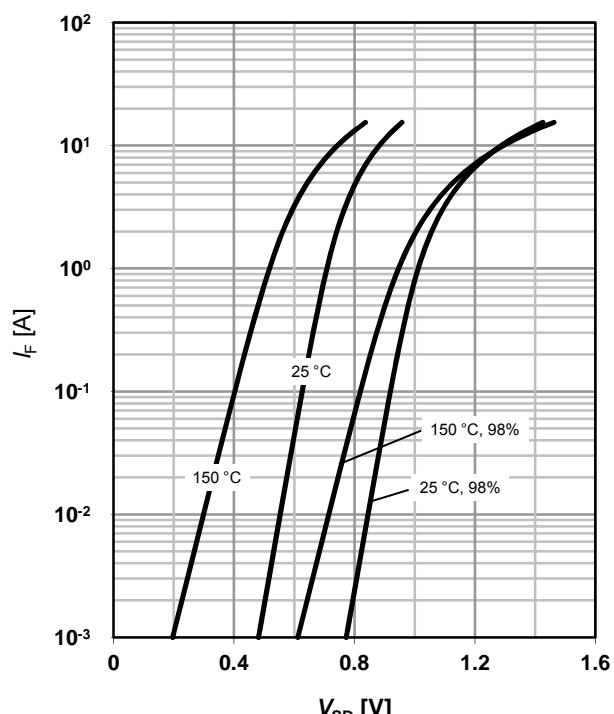
$$Z_{\text{thJA}} = f(t_p)$$

 parameter:  $D = t_p/T$ 


**5 Typ. output characteristics**
 $I_D = f(V_{DS})$ ;  $T_j = 25^\circ\text{C}$ 
parameter:  $V_{GS}$ 
**6 Typ. drain-source on resistance**
 $R_{DS(on)} = f(I_D)$ ;  $T_j = 25^\circ\text{C}$ 
parameter:  $V_{GS}$ 
**7 Typ. transfer characteristics**
 $I_D = f(V_{GS})$ ;  $|V_{DS}| > 2|I_D|R_{DS(on)max}$ 

**8 Typ. forward transconductance**
 $g_{fs} = f(I_D)$ ;  $T_j = 25^\circ\text{C}$ 


**9 Drain-source on-state resistance**
 $R_{DS(on)} = f(T_j); I_D = 3.8 \text{ A}; V_{GS} = 4.5 \text{ V}$ 

**10 Typ. gate threshold voltage**
 $V_{GS(th)} = f(T_j); V_{DS} = V_{GS}; I_D = 30 \mu\text{A}$ 

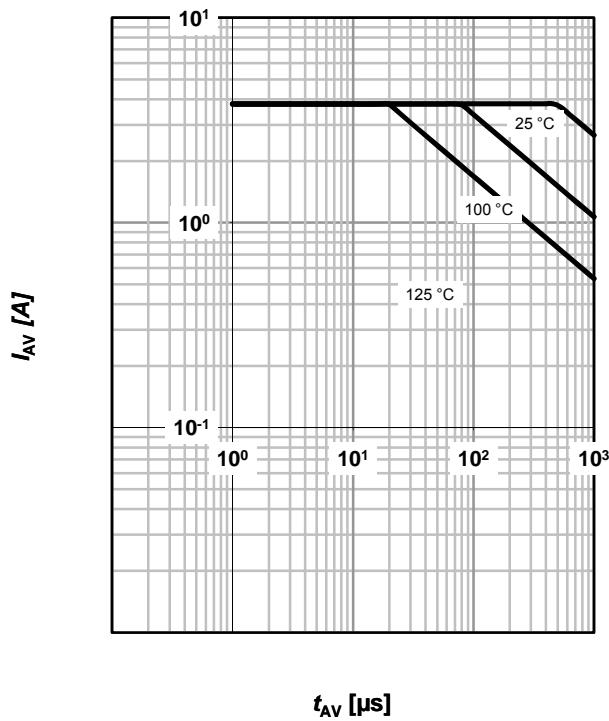
 parameter:  $I_D$ 

**11 Typ. capacitances**
 $C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}; T_j = 25^\circ\text{C}$ 

**12 Forward characteristics of reverse diode**
 $I_F = f(V_{SD})$ 

 parameter:  $T_j$ 


### 13 Avalanche characteristics

$I_{AV}=f(t_{AV})$ ;  $R_{GS}=25 \Omega$

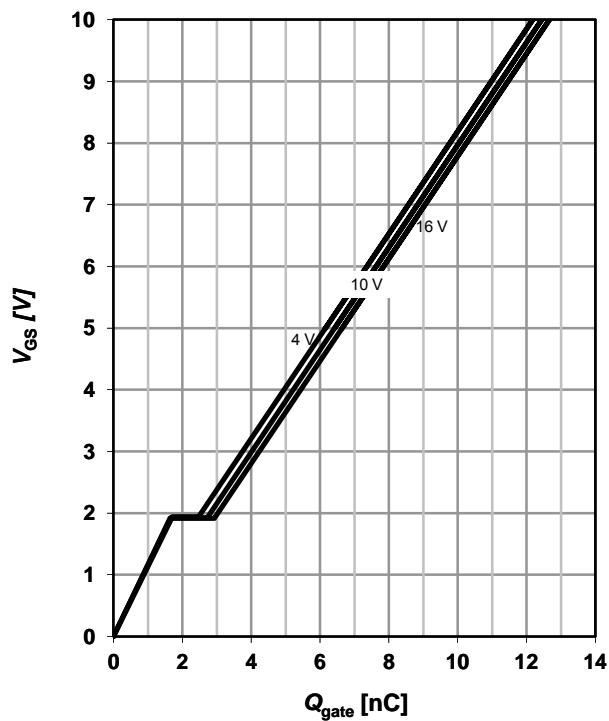
parameter:  $T_j(\text{start})$



### 14 Typ. gate charge

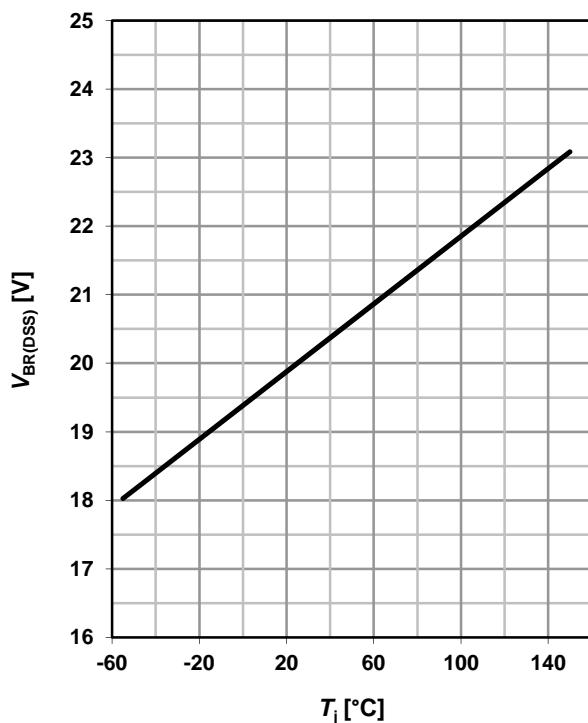
$V_{GS}=f(Q_{gate})$ ;  $I_D=3.8 \text{ A pulsed}$

parameter:  $V_{DD}$

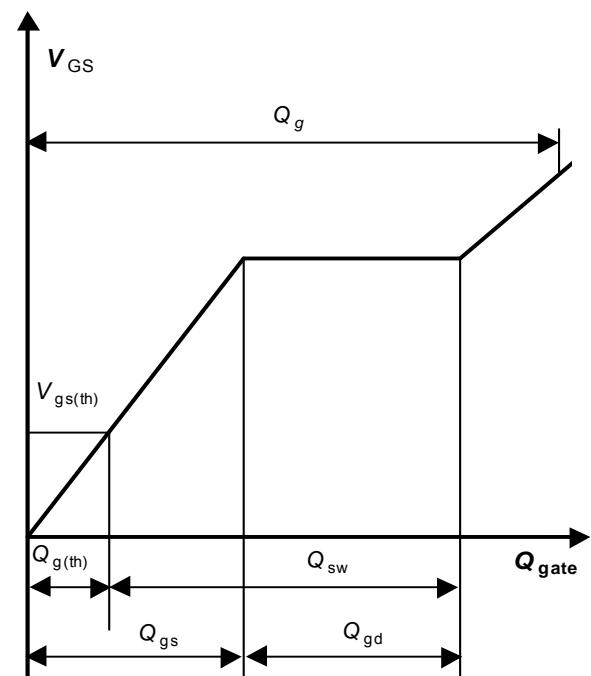


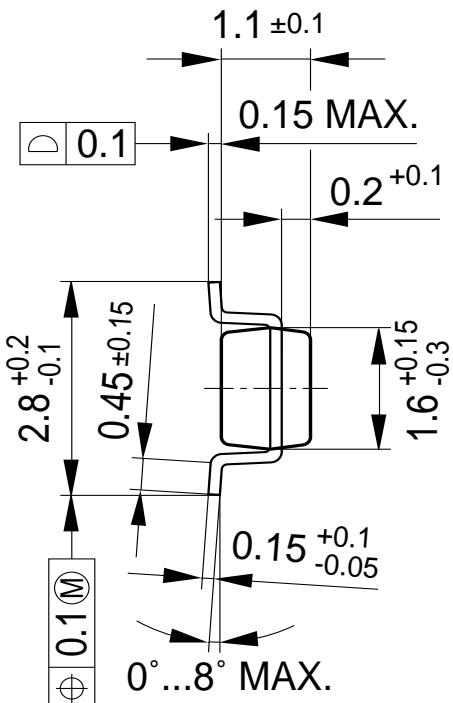
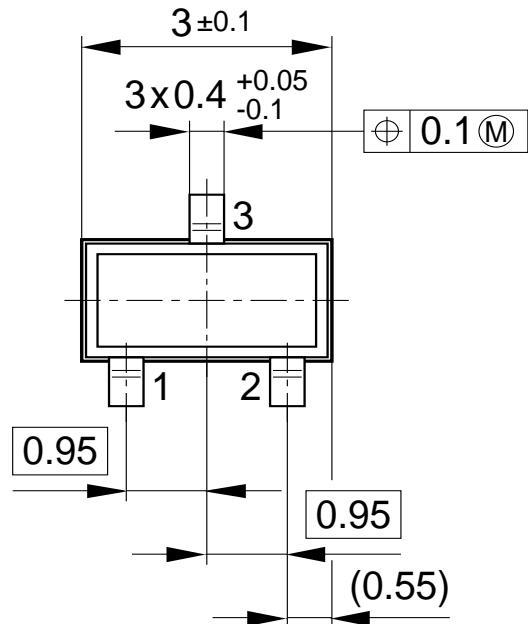
### 15 Drain-source breakdown voltage

$V_{BR(DSS)}=f(T_j)$ ;  $I_D=250 \mu\text{A}$

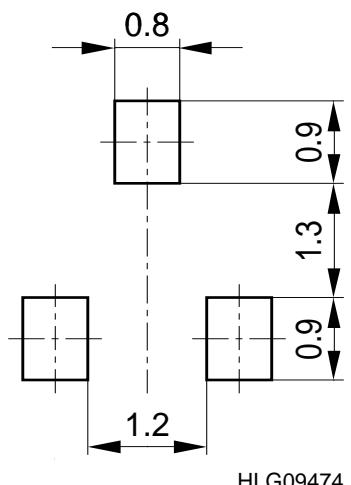


### 16 Gate charge waveforms



**Package Outline:**
**PG-SC59**


GPS09473

**Footprint:**


HLG09474

Dimensions in mm

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